HALOGEN

**FREE** 



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### Vishay General Semiconductor

# **High Voltage Ultrafast Avalanche SMD Rectifiers**



**DO-214AC (SMA)** 

PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	1.0 A			
V <sub>RRM</sub>	1300 V			
I <sub>FSM</sub>	18 A			
t <sub>rr</sub>	75 ns			
E <sub>R</sub>	5 mJ			
V <sub>F</sub> at I <sub>F</sub> = 1.0 A (T <sub>A</sub> = 125 °C)	1.39 V			
T <sub>J</sub> max.	150 °C			
Package	DO-214AC (SMA)			
Diode variations	Single die			

#### TYPICAL APPLICATIONS

For use in high voltage, high frequency rectification specially suited for freewheeling, clamping, snubbering in power supply, ignition drive of HID, UHP and industrial ballast and snubber for PDP TV power supply application.

#### **FEATURES**

- Glass passivated junction
- · Low profile package
- Ideal for automated placement
- Low reverse current
- High reverse voltage
- · Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **MECHANICAL DATA**

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test **Polarity:** Color band denotes the cathode end

<b>MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	BYG23T	UNIT	
Device marking code		BYG23T		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	1300	V	
Maximum DC forward current (fig.1)	I <sub>F</sub> <sup>(1)</sup>	1.0	Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	18	А	
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 0.4 \text{ A}$ , $T_L = 25  ^{\circ}\text{C}$	E <sub>R</sub>	5	mJ	
Maximum operating junction temperature	TJ	150	°C	
Storage temperature range	T <sub>STG</sub>	- 55 to + 150	°C	

#### Note

• Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage (1)	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 25 °C	V <sub>F</sub>	1.74	1.9	V
		T <sub>A</sub> = 125 °C		1.39	1.65	
Reverse current (2)	V <sub>R</sub> = 1300 V	T <sub>A</sub> = 25 °C	— I <sub>R</sub>	-	5.0	μΑ
heverse current (=)	V <sub>R</sub> = 1300 V	T <sub>A</sub> = 125 °C		2.9	50	
Maximum reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$	T <sub>A</sub> = 25 °C	t <sub>rr</sub>	65	75	ns
Forward recovery time	I <sub>F</sub> = 1.5 A, dI/dt = 12 A/μs,	T <sub>A</sub> = 25 °C	t <sub>fr</sub>	620	-	115
Peak forward voltage	$V_F = 1.1 \times V_F \text{ max.}$	1A = 25 C	$V_{FP}$	9.0	-	V
Typical junction capacitance	4.0 V, 1 MHz		CJ	9.0	-	pF

#### Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	BYG23T	UNIT	
Typical thermal resistance (1)	$R_{\theta JA}$	120	°C/W	
Typical thermal resistance W	$R_{\theta JM}$	20		

#### Note

(1) Free air, mounted on recommended PCB 1 oz. pad area. Thermal resistance  $R_{\theta JA}$  - junction to ambient,  $R_{\theta JM}$  - junction to ambient  $R_{\theta JM}$  - junction to ambient

ORDERING INFORMATION (Example)				
PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE		BASE QANTITY	DELIVERY MODE	
BYG23T-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG23T-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel

### **RATINGS AND CHARACTERISTICS CURVES** (T<sub>A</sub> = 25 °C unless otherwise noted)

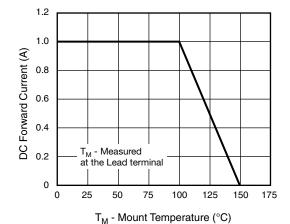


Fig. 1 - Max. Forward Current Derating Curve

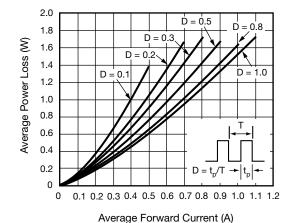


Fig. 2 - Forward Power Loss Characteristics



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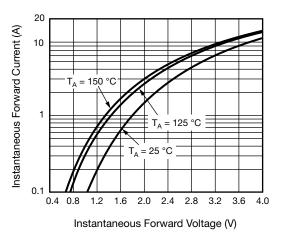


Fig. 3 - Typical Instantaneous Forward Characteristics

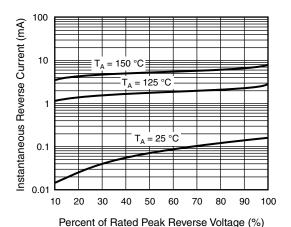


Fig. 4 - Typical Reverse Characteristics

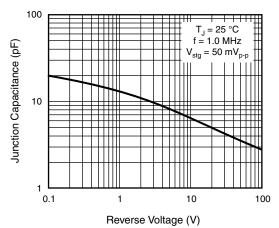


Fig. 5 - Typical Junction Capacitance

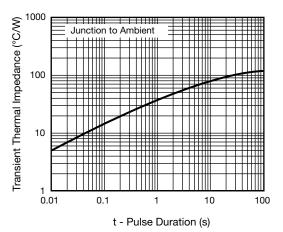
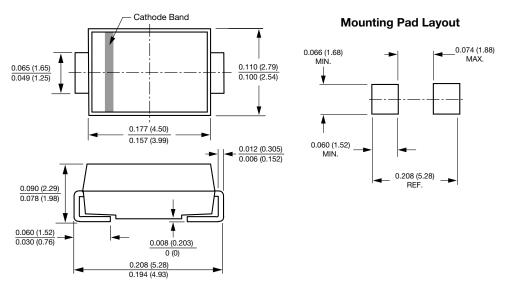


Fig. 6 - Typical Transient Thermal Impedance

#### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### DO-214AC (SMA)





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